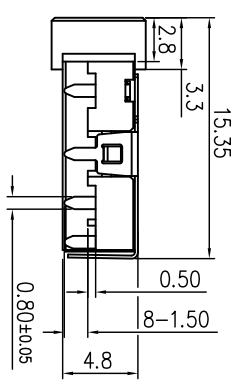
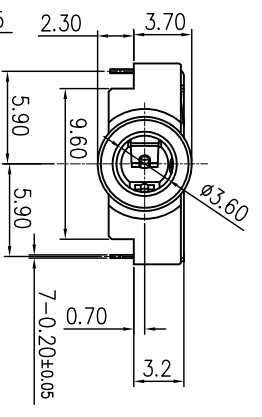
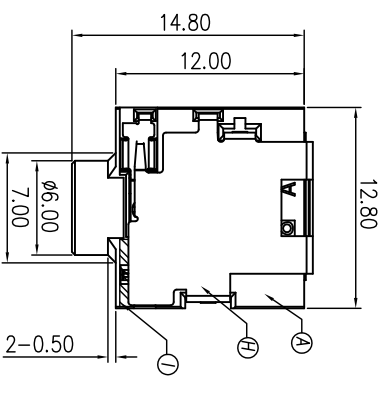
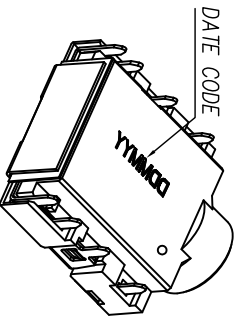

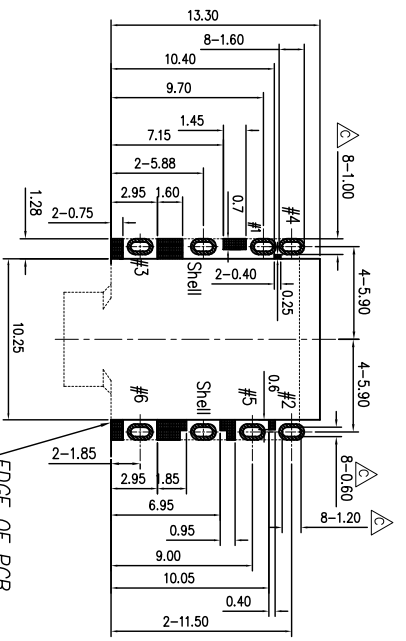
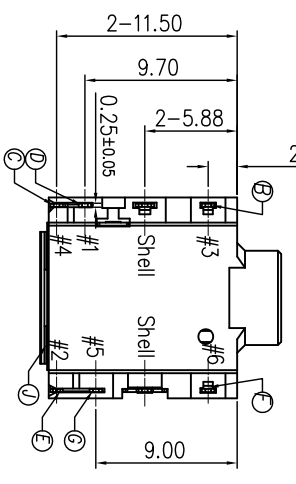


REV.	ECN NO OR DESCRIPTION	REVISED	DATE
A	PRODUCT RELEASE	ZJS	2012.8.22
B	ECN:C120307 MODIFY STRUCTURE	LONGJING	2012.10.10
C	ECN:C140074 MODIFY LAYOUT	ZJS	2014.8.1

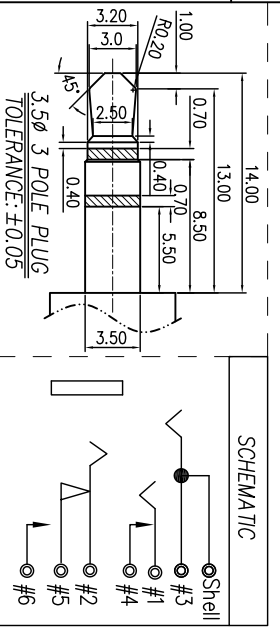
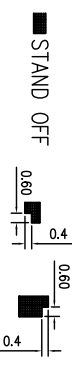


SPECIFICATIONS:

- ELECTRICAL CHARACTERISTICS:
 - RATING: 36V, 1A.
 - CONTACT RESISTANCE: 50mΩ MAX.
 - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE.
 - INSULATION RESISTANCE: 100mΩ MIN. MEASURED BY 500 VDC.
- MECHANICAL CHARACTERISTICS:
 - INSERTION FORCE : 0.4~3.0 KGF
 - WITHDRAWAL FORCE : 0.3~2.0 KGF
 - LIFE TEST: 5,000 CYCLES MIN.
 - OTHER GENERAL SPEC. TO REFER "2SJ2285 SERIES SPEC."
 - TO CONFORM TO THE SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
 - HALOGEN FREE PRODUCT IDENTIFICATION MARK ON JACK. 
 - HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING.
 - FOR REFLOW SOLDERING LEAD-FREE PROCESS.
 - PACKAGING: TAPE&REEL.



RECOMMENDED P.C.B. LAYOUT T=1.20
TOP VIEW (TOLERANCE: ±0.05)



I	MYLAR	1	MYLAR 0.075T	NI PLATING
H	SHIELD	1	COPPER ALLOY 0.20T	
G	TRANSFER TERMINAL	1	COPPER ALLOY 0.20T	Gold Flash on contact area and Solder tail over Nickel Plated
F	MAKE TERMINAL	1	COPPER ALLOY 0.20T	Gold Flash on contact area and Solder tail over Nickel Plated
E	RING	1	COPPER ALLOY 0.20T	Gold Flash on contact area and Solder tail over Nickel Plated
D	TIP	1	COPPER ALLOY 0.25T	Gold Flash on contact area and Solder tail over Nickel Plated
C	SHUNT	1	COPPER ALLOY 0.20T	GOLD FLASH
B	EARTH	1	COPPER ALLOY 0.20T	GOLD FLASH
A	BODY	1	HIGH TEMP THERMOPLASTIC UL 94V-0	BLACK COLOR
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS: ANGLES:
 X : ±0.5 X : ±2°
 X.X : ±0.3 X.X : ±1'
 X.XX : ±0.2

TITLE: 3.5Ø PHONE JACK

Singatron Enterprise Co., Ltd.
 信音企業股份有限公司

DWN ZJS 14/8/19 PART NO. 2SJ2285-003152F
 CHKD BULY 14/8/19 SCALE 3:1 UNIT: mm
 APVD ZZZ 14/8/19 SIZE: A3 SHEET: 10F1 REV: C

CUSTOMER COPY